Product data sheet

1. Product profile

1.1 General description

The BFR540 is an NPN silicon planar epitaxial transistor in a SOT23 plastic package.

1.2 Features and benefits

- High power gain
- Low noise figure
- High transition frequency
- Gold metallization ensures excellent reliability.

1.3 Applications

- RF front end wideband applications in the GHz range
 - Analog and digital cellular telephones
 - ◆ Cordless telephones (CT1, CT2, DECT, etc.)
 - Radar detectors
 - Satellite TV tuners (SATV)
 - ◆ MATV/CATV amplifiers
 - Repeater amplifiers in fiber-optic systems.

1.4 Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V_{CBO}	collector-base voltage	open emitter		-	-	20	V
V _{CES}	collector-emitter voltage	$R_{BE} = 0 \Omega$		-	-	15	V
I _C	collector current (DC)			-	-	120	mΑ
P _{tot}	total power dissipation	T _{sp} ≤ 70 °C	[1]	-	-	500	mW
h _{FE}	DC current gain	$I_C = 40 \text{ mA}; V_{CE} = 8 \text{ V}$		100	120	250	
C _{re}	feedback capacitance	$I_C = I_c = 0 \text{ A}; V_{CB} = 8 \text{ V};$ f = 1 MHz		-	0.6	-	pF
f _T	transition frequency	$I_C = 40 \text{ mA}; V_{CE} = 8 \text{ V};$ f = 1 GHz		-	9	-	GHz
G _{UM}	maximum unilateral power gain	I_{C} = 40 mA; V_{CE} = 8 V; T_{amb} = 25 °C					
		f = 900 MHz		-	14	-	dB
		f = 2 GHz		-	7	-	dB



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Table 1. Quick reference data ...continued

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
S ₂₁ ²	insertion power gain	$I_C = 40 \text{ mA}; V_{CE} = 8 \text{ V};$ $T_{amb} = 25 ^{\circ}\text{C};$ f = 900 MHz	12	13	-	dB
NF noise figure	$\Gamma_{\text{S}} = \Gamma_{\text{opt}}$; $V_{\text{CE}} = 8 \text{ V}$; $T_{\text{amb}} = 25 ^{\circ}\text{C}$					
		$I_C = 10 \text{ mA};$ f = 900 MHz	-	1.3	1.8	dB
	$I_C = 40 \text{ mA};$ f = 900 MHz	-	1.9	2.4	dB	
		$I_C = 10 \text{ mA};$ f = 2 GHz	-	2.1	-	dB

^[1] T_{sp} is the temperature at the soldering point of the collector tab.

2. Pinning information

Table 2. Pinning

Table 2.	rinning	
Pin	Description	Simplified outline Symbol
1	base	
2	emitter	3
3	collector	1
		sym021

3. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
BFR540	-	plastic surface mounted package; 3 leads	SOT23

4. Marking

Table 4. Marking

Type number	Marking code ^[1]
BFR540	33*

^{[1] * =} p: Made in Hong Kong

^{* =} t: Made in Malaysia

^{* =} W: Made in China.

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5. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CBO}	collector-base voltage	open emitter	-	20	V
V _{CES}	collector-emitter voltage	$R_{BE} = 0 \Omega$	-	15	V
V _{EBO}	emitter-base voltage	open collector	-	2.5	V
I _C	collector current (DC)		-	120	mA
P _{tot}	total power dissipation	$T_{sp} \le 70 ^{\circ}C$	[1] -	500	mW
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		-	175	°C

^[1] T_{sp} is the temperature at the soldering point of the collector tab.

6. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions	Тур	Unit
$R_{th(j-sp)}$	thermal resistance from junction to soldering point		[1] 260	K/W

^[1] T_{sp} is the temperature at the soldering point of the collector tab.

7. Characteristics

Table 7. Characteristics

 $T_j = 25$ °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I _{CBO}	collector cut-off current	$I_E = 0 \text{ A}; V_{CB} = 8 \text{ V}$	-	-	50	nA
h _{FE}	DC current gain	$I_C = 40 \text{ mA}; V_{CE} = 8 \text{ V}$	100	120	250	
C _e	emitter capacitance	$I_C = I_c = 0 A; V_{EB} = 0.5 V;$ f = 1 MHz	-	2	-	pF
C _c	collector capacitance	$I_E = i_e = 0 A; V_{CB} = 8 V;$ f = 1 MHz	-	0.9	-	pF
C_{re}	feedback capacitance	$I_C = 0 \text{ A}; V_{CB} = 8 \text{ V};$ f = 1 MHz	-	0.6	-	pF
f _T	transition frequency	$I_C = 40 \text{ mA}; V_{CE} = 8 \text{ V};$ f = 1 GHz	-	9	-	GHz
G _{UM}	maximum unilateral power	$I_C = 40 \text{ mA}; V_{CE} = 8 \text{ V};$ $T_{amb} = 25 ^{\circ}\text{C}$	[1]			
	gain	f = 900 MHz	-	14	-	dB
		f = 2 GHz	-	7	-	dB
$ s_{21} ^2$	insertion power gain	$I_C = 40$ mA; $V_{CE} = 8$ V; $T_{amb} = 25$ °C; $f = 900$ MHz	12	13	-	dB

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Table 7. Characteristics ...continued $T_i = 25$ °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
NF noise figure		$\Gamma_{\text{s}} = \Gamma_{\text{opt}}$; $V_{\text{CE}} = 8 \text{ V}$; $T_{\text{amb}} = 25 \text{ °C}$				
		$I_C = 10 \text{ mA}; f = 900 \text{ MHz}$	-	1.3	1.8	dB
		$I_C = 40 \text{ mA}$; $f = 900 \text{ MHz}$	-	1.9	2.4	dB
		$I_C = 10 \text{ mA}; f = 2 \text{ GHz}$	-	2.1	-	dB
P _{L(1dB)}	output power at 1 dB gain compression	$I_{C} = 40$ mA; $V_{CE} = 8$ V; $R_{L} = 50 \Omega$; $T_{amb} = 25$ °C; f = 900 MHz	-	21	-	dBm
ITO	third order intercept point		[2] _	34	-	dBm
Vo	output voltage	$I_{C} = 40 \text{ mA}; V_{CE} = 8 \text{ V};$ $Z_{L} = Z_{S} = 75 \Omega;$ $T_{amb} = 25 \text{ °C}$	[3]	550	-	mV

[1] G_{UM} is the maximum unilateral power gain, assuming s_{12} is zero and

$$G_{UM} = 10 \log \frac{|s_{2I}|^2}{(1-|s_{II}|^2)(1-|s_{22}|^2)} dB.$$

- [2] I_C = 40 mA; V_{CE} = 8 V; R_L = 50 Ω ; T_{amb} = 25 °C; f = 900 MHz; f_p = 900 MHz; f_q = 902 MHz. Measured at $f_{(2p-q)}$ = 898 MHz and $f_{(2q-p)}$ = 904 MHz.
- [3] $d_{im} = -60$ dB (DIN 45004B); $V_p = V_O$; $V_q = V_O 6$ dB; $f_p = 795.25$ MHz; $V_R = V_O 6$ dB; $f_q = 803.25$ MHz; $f_r = 805.25$ MHz. Measured at $f_{(p+q-r)} = 793.25$ MHz.

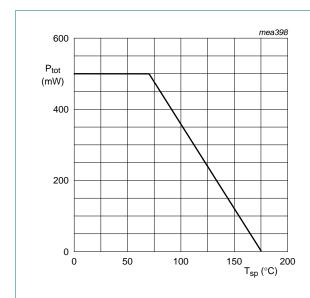
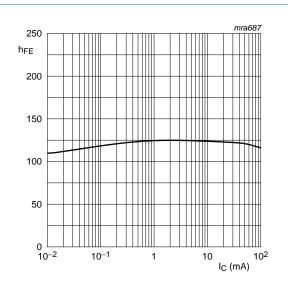


Fig 1. Power derating curve.



 $V_{CE} = 8 \text{ V}.$

Fig 2. DC current gain as a function of collector current.

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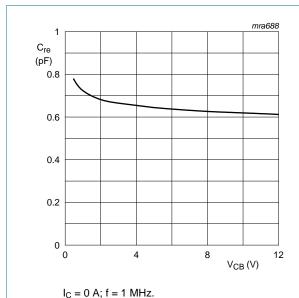


Fig 3. Feedback capacitance as a function of collector-base voltage.

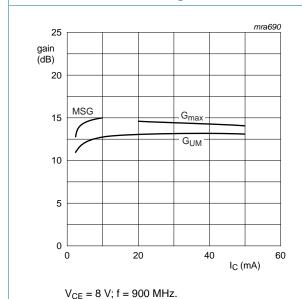


Fig 5. Gain as a function of collector current.

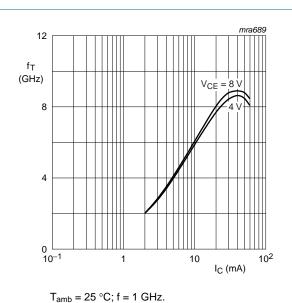
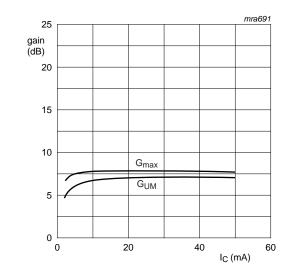


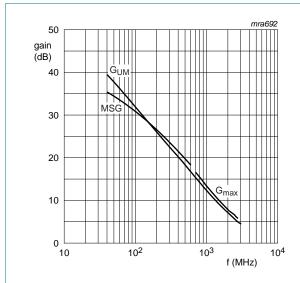
Fig 4. Transition frequency as a function of collector current.



 $V_{CE} = 8 \text{ V; } f = 2 \text{ GHz.}$

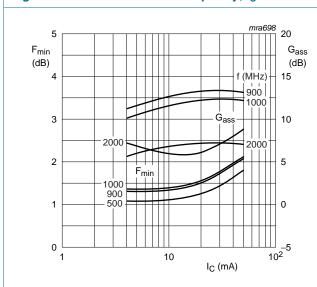
Fig 6. Gain as a function of collector current.

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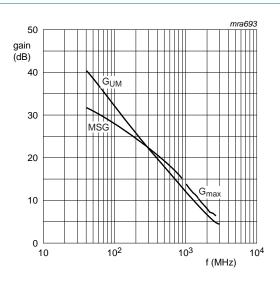
 $V_{CE} = 8 \text{ V}; I_{C} = 10 \text{ mA}.$

Fig 7. Gain as a function of frequency; $I_C = 10$ mA.



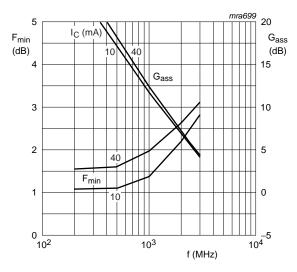
V_{CE} = 8 V.

Fig 9. Minimum noise figure and associated available gain as a function of collector current.



 $V_{CE} = 8 \text{ V}; I_{C} = 40 \text{ mA}.$

Fig 8. Gain as a function of frequency; $I_C = 40$ mA.



 $V_{CE} = 8 \text{ V}.$

Fig 10. Minimum noise figure and associated available gain as a function of frequency.

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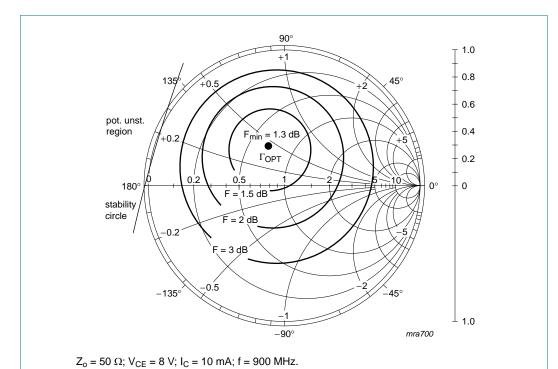
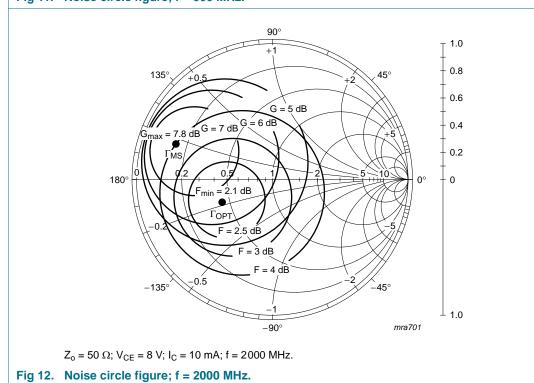


Fig 11. Noise circle figure; f = 900 MHz.



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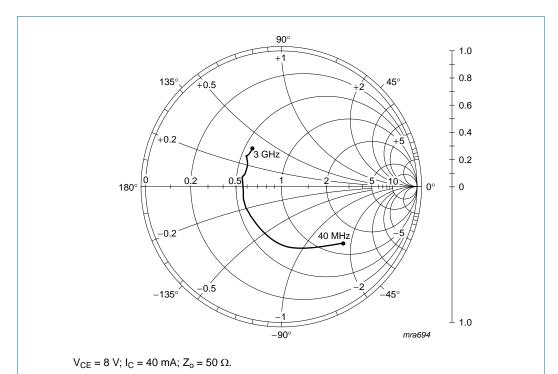
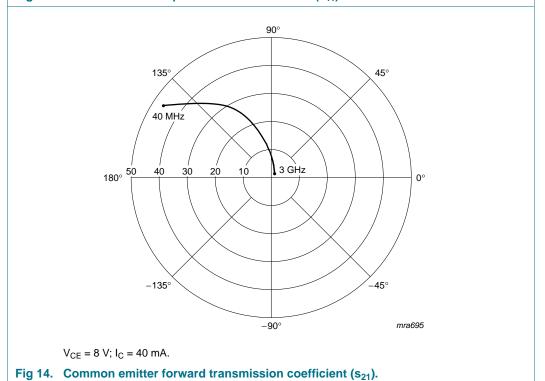


Fig 13. Common emitter input reflection coefficient (s₁₁).



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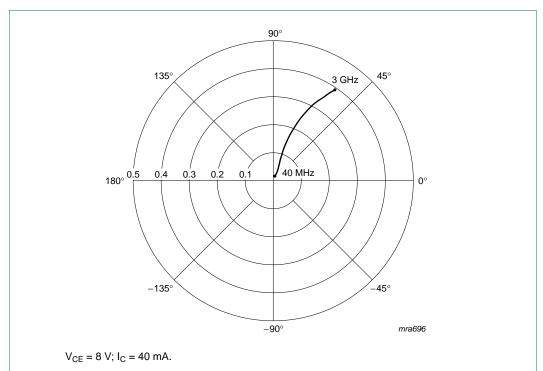


Fig 15. Common emitter reverse transmission coefficient (s₁₂).

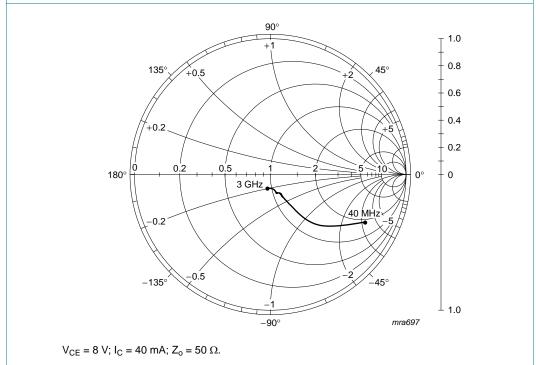


Fig 16. Common emitter output reflection coefficient (s₂₂).

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8. Package outline

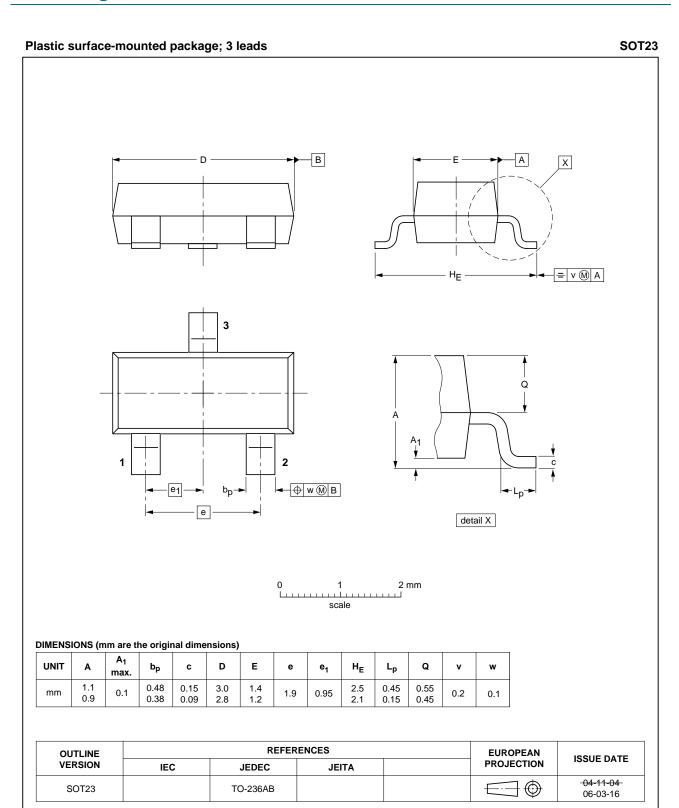


Fig 17. Package outline SOT23 (T0-236AB).

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9. Revision history

Table 8. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BFR540 v.6	20110913	Product data sheet	-	BFR540 v.5
Modifications:		of this data sheet has been of NXP Semiconductors.	redesigned to comply w	vith the new identity
	 Legal texts 	have been adapted to the n	ew company name whe	ere appropriate.
	 Package ou 	ıtline drawings have been u	odated to the latest vers	sion.
BFR540 v.5 (9397 750 13398)	20040901	Product data sheet	-	BFR540 v.4
BFR540 v.4 (9397 750 07062)	20000530	Product specification	-	BFR540 v.3
BFR540 v.3 (9397 750 06338)	19990823	Product specification	-	BFR540_CNV v.2
BFR540_CNV v.2	19971204	Product specification	-	-

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10. Legal information

10.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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BFR540 NXP Semiconductors

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